10/02/2020 506286598

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6333346

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
AMIT K SRIVASTAVA	03/03/2020
MAJID SHUSHTARIAN	03/03/2020
ANAND K ENAMANDRAM	06/01/2020
JARED W HAVICAN	06/01/2020
JEFFREY A PIHLMAN	03/25/2020
MICHAEL J KARAS	03/04/2020
RAMAMURTHY KRITHIVAS	08/25/2020
CHRISTINE WATNIK	03/10/2020

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16790648

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4254174729

Email: alan@patentlylegal.com

ALAN BURNETT Correspondent Name:

4108 131ST AVE SE Address Line 1:

Address Line 4: BELLEVUE, WASHINGTON 98006

ATTORNEY DOCKET NUMBER:	AC4628-US
NAME OF SUBMITTER:	R. ALAN BURNETT
SIGNATURE:	/R. Alan Burnett/

PATENT REEL: 053961 FRAME: 0641

506286598

DATE SIGNED:	10/02/2020									
Total Attachments: 12										
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PATENT REEL: 053961 FRAME: 0642

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Amit K Srivastava; Majid Shushtarian; Anand K Enamandram; Jared W Havican; Jeffrey A Pihlman; Michael J Karas; Ramamurthy Krithivas; Christine Watnik

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

METHOD TO DYNAMICALLY CONFIGURE MONITOR AND GOVERN THE MULTIPLE CHIPSETS IN THE SYSTEM TO ACT AS EXTENDED HIGH SPEED IO EXPANDER(S)

which was filed on	February 13, 2	2020		as
US		Application Number	16/790,648	anc
COUNTRY or Inter	rnational Office			<u> </u>

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and

PATENT REEL: 053961 FRAME: 0643

Amit	3/3/2020
Amit K Srivastava	Date signed
Majid Shushtarian	Date signed
Anand K Enamandram	Date signed
Jared W Havican	Date signed
Jeffrey A Pihlman	Date signed
Michael J Karas	Date signed
Ramamurthy Krithivas	Date signed
Christine Watnik	Date signed

<u>assignment</u>

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Marin 1972

REEL 053961 FRAME: 0645

Amit K Srivastava Majid Shushtarian	Date signed 7/3/20 Date signed
Anand K Enamandram	Date signed
Jared W Havican	Date signed
Jeffrey A Pihlman	Date signed
Michael J Karas	Date signed
Ramamurthy Krithivas	Date signed
Chestine Waltik	Date signed

the history thereof, and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Amit K Srivastava	Date signed
Majid Shushtarian	Date signed
AL.	0 6 /01/2020 Date signed
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Jared W Havican	Date signed
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Michael J Karas	Date signed
Ramamurthy Krithivas	Date signed
Christine Watnik	Date signed

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PATENT REEL: 053961 FRAME: 0648

Amit K Srivastava	Date signed
Majid Shushtarian	Date signed
Anand K Enamandram	Date signed
Jul D	6/1/2020
Jared W Havican	Date signed
Jeffrey A Pihlman	Date signed
Michael J Karas	Date signed
	-
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Page 1 of 2

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Michael J Karas	Date signed
Ramamurthy Krithivas	Date signed
Christine Watnik	Date signed

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Amit K. Srivastava	Date signed
Majid Shushtarian	Date signed
Anand K Enamandram	Date signed
Jared W Havican	Date signed
Jeffrey A Pihlman	Date signed
Michael J Karas	Date signed
P. Mulhur	08/25/2020
Ramamurthy Krithivas	Date signed
Christine Watnik	Date signed

Page 2 of 2 PATEN

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Christine Watnik	3 10 1 20 20 Date signed
Christine waunk	Date signed

Page 2 of 2